

Part Number: 877600816

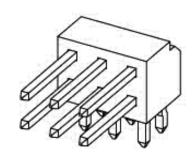
Product Description : 2.00mm Pitch Milli-Grid Header, Right-Angle, Through Hole, 8 Circuits, 0.38µm

Gold (Au) Selective Plating, Tray, Lead-Free

Series Number: 87760

Status: Active

Product Category : PCB Headers and Receptacles



Documents & Resources

Drawings

877600816 sd.pdf

PK-89990-487-001.pdf

3D Models and Design Files

877600816_stp.zip

Specifications

503940001-AS-000.pdf

PS-87761-100-001.pdf

877610000-TS-000.pdf

Product Environment Compliance

Compliance

GADSL/IMDS	Compliant with Exemption 44; 34; 33
China RoHS	⊚ per SJ/T 11365-2006
EU ELV	Not Relevant
Low-Halogen Status	Not Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2024)6225-DC (07 Nov 2024)
EU RoHS	Compliant per EU 2015/863

Compliance Statements

- EU RoHS
- REACH SVHC
- Low-Halogen

Industry Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

Substances of Interest

PFAS

EU RoHS Certificate of Compliance

Additional Product Compliance Information

Part Details

General

Status	Active
Category	PCB Headers and Receptacles
Series	87760
Description	2.00mm Pitch Milli-Grid Header, Right-Angle, Through Hole, 8 Circuits, 0.38µm Gold (Au) Selective Plating, Tray, Lead-Free
Application	Board-to-Board, Signal, Wire-to- Board
Comments	Lead-Free version of 87049 series
Component Type	PCB Header
Product Name	Milli-Grid
UPC	822348231690

Agency

CSA	LR19980
UL	E29179

Electrical

Current - Maximum per Contact	2.0A
Voltage - Maximum	125V

Physical

Breakaway	No
Circuits (Loaded)	8
Circuits (maximum)	8
Color - Resin	Black
First Mate / Last Break	No
Flammability	94V-0
Glow-Wire Capable	No
Guide to Mating Part	No
Keying to Mating Part	None
Lock to Mating Part	None
Mated Height	4.00mm
Material - Metal	Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Net Weight	0.327/g
Number of Rows	2
Orientation	Right Angle
Packaging Type	Tray
PCB Locator	No
PCB Retention	None
PCB Thickness - Recommended	1.60mm
PC Tail Length	2.60mm
Pitch - Mating Interface	2.00mm
Pitch - Termination Interface	2.00mm
Plating min - Mating	0.381µm
Plating min - Termination	1.905µm
Polarized to Mating Part	No
Polarized to PCB	No
Shrouded	No
Stackable	Yes
Temperature Range - Operating	-55° to +105°C
Termination Interface Style	Through Hole

Solder Process Data

Max-Duration	14
Lead-Free Process Capability	WAVE
Max-Cycle	1
Max-Temp	265

Mates With / Use With

Mates with Part(s)

Description	Part Number
Milli-Grid Vertical Through Hole PCB Receptacles	<u>78787</u>
Milli-Grid Vertical Through Hole PCB Receptacles	<u>79107</u>
Milli-Grid Vertical Through Hole PCB Receptacles	<u>79108</u>
Milli-Grid Top Entry Surface Mount PCB Receptacles	<u>78788</u>
Milli-Grid Top/Bottom Entry Surface Mount PCB Receptacles	<u>79109</u>
Milli-Grid Top Entry Surface Mount PCB Receptacles	<u>87381</u>
Milli-Grid Side Entry Through Hole PCB Receptacles	<u>87264</u>

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